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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.173", 4.40mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f041ahj020sg

Block Diagram

Figure 1 displays the block diagram of the architecture of the Z8 Encore! XP F082A Series devices.

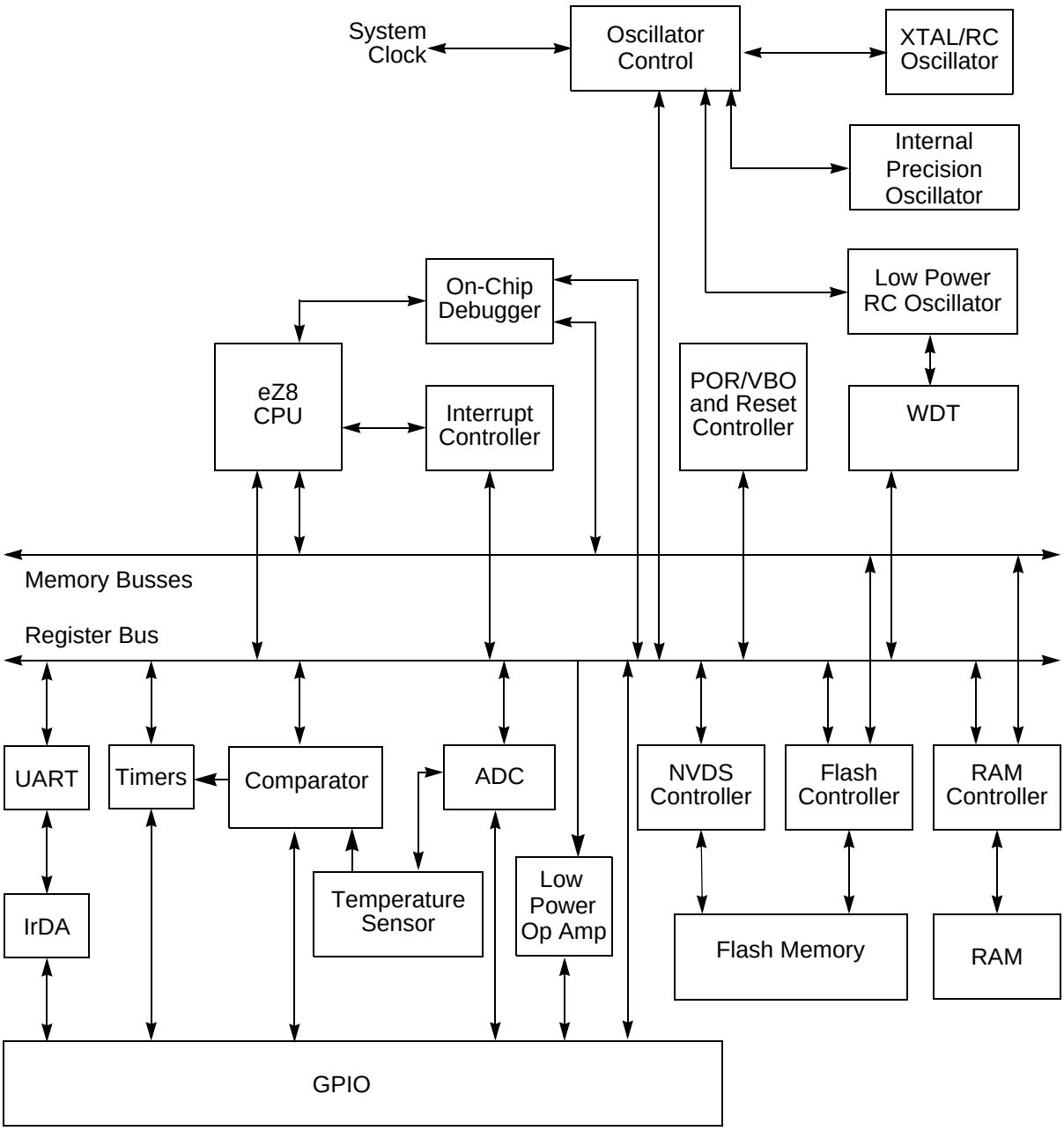


Figure 1. Z8 Encore! XP F082A Series Block Diagram

CPU and Peripheral Overview

The eZ8 CPU, Zilog's latest 8-bit Central Processing Unit (CPU), meets the continuing demand for faster and more code-efficient microcontrollers. The eZ8 CPU executes a superset of the original Z8 instruction set. The features of eZ8 CPU include:

- Direct register-to-register architecture allows each register to function as an accumulator, improving execution time and decreasing the required program memory
- Software stack allows much greater depth in subroutine calls and interrupts than hardware stacks
- Compatible with existing Z8 code
- Expanded internal Register File allows access of up to 4 KB
- New instructions improve execution efficiency for code developed using higher-level programming languages, including C
- Pipelined instruction fetch and execution
- New instructions for improved performance including BIT, BSWAP, BTJ, CPC, LDC, LDCI, LEA, MULT and SRL
- New instructions support 12-bit linear addressing of the Register File
- Up to 10 MIPS operation
- C-Compiler friendly
- 2 to 9 clock cycles per instruction

For more information about eZ8 CPU, refer to the eZ8 CPU Core User Manual (UM0128), which is available for download on www.zilog.com.

10-Bit Analog-to-Digital Converter

The optional analog-to-digital converter (ADC) converts an analog input signal to a 10-bit binary number. The ADC accepts inputs from eight different analog input pins in both single-ended and differential modes. The ADC also features a unity gain buffer when high input impedance is required.

Low-Power Operational Amplifier

The optional low-power operational amplifier (LPO) is a general-purpose amplifier primarily targeted for current sense applications. The LPO output may be routed internally to the ADC or externally to a pin.

Table 7. Register File Address Map (Continued)

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page
F85	Reserved	—	XX	
Oscillator Control				
F86	Oscillator Control	OSCCTL	A0	196
F87–F8F	Reserved	—	XX	
Comparator 0				
F90	Comparator 0 Control	CMP0	14	141
F91–FBF	Reserved	—	XX	
Interrupt Controller				
FC0	Interrupt Request 0	IRQ0	00	60
FC1	IRQ0 Enable High Bit	IRQ0ENH	00	63
FC2	IRQ0 Enable Low Bit	IRQ0ENL	00	63
FC3	Interrupt Request 1	IRQ1	00	61
FC4	IRQ1 Enable High Bit	IRQ1ENH	00	65
FC5	IRQ1 Enable Low Bit	IRQ1ENL	00	65
FC6	Interrupt Request 2	IRQ2	00	62
FC7	IRQ2 Enable High Bit	IRQ2ENH	00	66
FC8	IRQ2 Enable Low Bit	IRQ2ENL	00	67
FC9–FCC	Reserved	—	XX	
FCD	Interrupt Edge Select	IRQES	00	68
FCE	Shared Interrupt Select	IRQSS	00	68
FCF	Interrupt Control	IRQCTL	00	69
GPIO Port A				
FD0	Port A Address	PAADDR	00	44
FD1	Port A Control	PACTL	00	46
FD2	Port A Input Data	PAIN	XX	46
FD3	Port A Output Data	PAOUT	00	46
GPIO Port B				
FD4	Port B Address	PBADDR	00	44
FD5	Port B Control	PBCTL	00	46
FD6	Port B Input Data	PBIN	XX	46
FD7	Port B Output Data	PBOUT	00	46
GPIO Port C				
FD8	Port C Address	PCADDR	00	44

Notes:
1. XX = Undefined.
2. Refer to the eZ8 CPU Core User Manual (UM0128).

PA0 and PA6 contain two different timer functions, a timer input and a complementary timer output. Both of these functions require the same GPIO configuration, the selection between the two is based on the timer mode. See **the** Timers **chapter on page 70** for more details.

Caution: For pins with multiple alternate functions, Zilog recommends writing to the AFS1 and AFS2 subregisters before enabling the alternate function via the AF subregister. As a result, spurious transitions through unwanted alternate function modes will be prevented.

Direct LED Drive

The Port C pins provide a current sinked output capable of driving an LED without requiring an external resistor. The output sinks current at programmable levels of 3 mA, 7 mA, 13 mA and 20 mA. This mode is enabled through the LED control registers. The LED Drive Enable (LEDEN) Register turns on the drivers. The LED Drive Level (LEDLVLH and LEDLVLL) registers select the sink current.

For correct function, the LED anode must be connected to V_{DD} and the cathode to the GPIO pin. Using all Port C pins in LED drive mode with maximum current may result in excessive total current. See **the** Electrical Characteristics chapter on page 226 for the maximum total current for the applicable package.

Shared Reset Pin

On the 20- and 28-pin devices, the PD0 pin shares function with a bidirectional reset pin. Unlike all other I/O pins, this pin does not default to GPIO function on power-up. This pin acts as a bidirectional input/open-drain output reset until the software reconfigures it. The PD0 pin is an output-only open drain when in GPIO mode. There are no pull-up, High Drive, or Stop Mode Recovery source features associated with the PD0 pin.

On the 8-pin product versions, the reset pin is shared with PA2, but the pin is not limited to output-only when in GPIO mode.

Caution: If PA2 on the 8-pin product is reconfigured as an input, ensure that no external stimulus drives the pin low during any reset sequence. Since PA2 returns to its $\overline{\text{RESET}}$ alternate function during system resets, driving it Low holds the chip in a reset state until the pin is released.

If TPOL is set to 0, the ratio of the PWM output High time to the total period is represented by:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{Reload Value} - \text{PWM Value}}{\text{Reload Value}} \times 100$$

If TPOL is set to 1, the ratio of the PWM output High time to the total period is represented by:

$$\text{PWM Output High Time Ratio (\%)} = \frac{\text{PWM Value}}{\text{Reload Value}} \times 100$$

CAPTURE Mode

In CAPTURE Mode, the current timer count value is recorded when the appropriate external Timer Input transition occurs. The Capture count value is written to the Timer PWM High and Low Byte registers. The timer input is the system clock. The TPOL bit in the Timer Control Register determines if the Capture occurs on a rising edge or a falling edge of the Timer Input signal. When the Capture event occurs, an interrupt is generated and the timer continues counting. The INPCAP bit in TxCTL0 Register is set to indicate the timer interrupt is because of an input capture event.

The timer continues counting up to the 16-bit reload value stored in the Timer Reload High and Low Byte registers. Upon reaching the reload value, the timer generates an interrupt and continues counting. The INPCAP bit in TxCTL0 Register clears indicating the timer interrupt is not because of an input capture event.

Observe the following steps for configuring a timer for CAPTURE Mode and initiating the count:

1. Write to the Timer Control Register to:
   - Disable the timer
   - Configure the timer for CAPTURE Mode
   - Set the prescale value
   - Set the Capture edge (rising or falling) for the Timer Input
2. Write to the Timer High and Low Byte registers to set the starting count value (typically 0001H).
3. Write to the Timer Reload High and Low Byte registers to set the reload value.
4. Clear the Timer PWM High and Low Byte registers to 0000H. Clearing these registers allows the software to determine if interrupts were generated by either a capture event or a reload. If the PWM High and Low Byte registers still contain 0000H after the interrupt, the interrupt was generated by a Reload.

Table 64. UART Control 1 Register (U0CTL1)

Bit	7	6	5	4	3	2	1	0
Field	MPMD[1]	MPEN	MPMD[0]	MPBT	DEPOL	BRGCTL	RDAIRQ	IREN
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F43H							

Bit	Description
[7,5] MPMD[1,0]	**MULTIPROCESSOR Mode** If MULTIPROCESSOR (9-bit) Mode is enabled: 00 = The UART generates an interrupt request on all received bytes (data and address). 01 = The UART generates an interrupt request only on received address bytes. 10 = The UART generates an interrupt request when a received address byte matches the value stored in the Address Compare Register and on all successive data bytes until an address mismatch occurs. 11 = The UART generates an interrupt request on all received data bytes for which the most recent address byte matched the value in the Address Compare Register.
[6] MPEN	**MULTIPROCESSOR (9-bit) Enable** This bit is used to enable MULTIPROCESSOR (9-bit) Mode. 0 = Disable MULTIPROCESSOR (9-bit) Mode. 1 = Enable MULTIPROCESSOR (9-bit) Mode.
[4] MPBT	**Multiprocessor Bit Transmit** This bit is applicable only when MULTIPROCESSOR (9-bit) Mode is enabled. The 9th bit is used by the receiving device to determine if the data byte contains address or data information. 0 = Send a 0 in the multiprocessor bit location of the data stream (data byte). 1 = Send a 1 in the multiprocessor bit location of the data stream (address byte).
[3] DEPOL	**Driver Enable Polarity** 0 = DE signal is Active High. 1 = DE signal is Active Low.

Bit	Description (Continued)
[2] TDRE	**TDRE—Transmitter Data Register Empty** This bit indicates that the UART Transmit Data Register is empty and ready for additional data. Writing to the UART Transmit Data Register resets this bit. 0 = Do not write to the UART Transmit Data Register. 1 = The UART Transmit Data Register is ready to receive an additional byte to be transmitted.
[1] TXE	**Transmitter Empty** This bit indicates that the Transmit Shift Register is empty and character transmission is finished. 0 = Data is currently transmitting. 1 = Transmission is complete.
[0] CTS	**$\overline{\text{CTS}}$ Signal** When this bit is read it returns the level of the $\overline{\text{CTS}}$ signal. This signal is active Low.

UART Status 1 Register

This register contains multiprocessor control and status bits.

Table 66. UART Status 1 Register (U0STAT1)

Bit	7	6	5	4	3	2	1	0
Field	Reserved						NEWFRM	MPRX
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R/W	R/W	R	R
Address	F44H							

Bit	Description
[7:2]	**Reserved** These bits are reserved and must be programmed to 000000.
[1] NEWFRM	**New Frame** A status bit denoting the start of a new frame. Reading the UART Receive Data Register resets this bit to 0. 0 = The current byte is not the first data byte of a new frame. 1 = The current byte is the first data byte of a new frame.
[0] MPRX	**Multiprocessor Receive** Returns the value of the most recent multiprocessor bit received. Reading from the UART Receive Data Register resets this bit to 0.

UART Transmit Data Register

Data bytes written to the UART Transmit Data (UxTXD) Register, shown in Table 67, are shifted out on the TXDx pin. The Write-only UART Transmit Data Register shares a Register File address with the read-only UART Receive Data Register.

The window remains open until the count again reaches 8 (that is, 24 baud clock periods since the previous pulse was detected), giving the Endec a sampling window of minus four baud rate clocks to plus eight baud rate clocks around the expected time of an incoming pulse. If an incoming pulse is detected inside this window this process is repeated. If the incoming data is a logical 1 (no pulse), the Endec returns to the initial state and waits for the next falling edge. As each falling edge is detected, the Endec clock counter is reset, resynchronizing the Endec to the incoming signal, allowing the Endec to tolerate jitter and baud rate errors in the incoming datastream. Resynchronizing the Endec does not alter the operation of the UART, which ultimately receives the data. The UART is only synchronized to the incoming data stream when a Start bit is received.

Infrared Encoder/Decoder Control Register Definitions

All infrared endec configuration and status information is set by the UART Control registers as defined in the Universal Asynchronous Receiver/Transmitter section on page 99.

! Caution: To prevent spurious signals during IrDA data transmission, set the IREN bit in the UART Control 1 Register to 1 to enable the Infrared Encoder/Decoder before enabling the GPIO Port alternate function for the corresponding pin.

Temperature Sensor

The on-chip Temperature Sensor allows you to measure temperature on the die with either the on-board ADC or on-board comparator. This block is factory calibrated for in-circuit software correction. Uncalibrated accuracy is significantly worse, therefore the temperature sensor is not recommended for uncalibrated use.

Temperature Sensor Operation

The on-chip temperature sensor is a Proportional to Absolute Temperature (PTAT) topology. A pair of Flash option bytes contain the calibration data. The temperature sensor can be disabled by a bit in the Power Control Register 0 section on page 33 to reduce power consumption.

The temperature sensor can be directly read by the ADC to determine the absolute value of its output. The temperature sensor output is also available as an input to the comparator for threshold type measurement determination. The accuracy of the sensor when used with the comparator is substantially less than when measured by the ADC.

If the temperature sensor is routed to the ADC, the ADC must be configured in unity-gain buffered mode (for details, see the Input Buffer Stage section on page 133). The value read back from the ADC is a signed number, although it is always positive.

The sensor is factory-trimmed through the ADC using the external 2.0 V reference. Unless the sensor is retrimmed for use with a different reference, it is most accurate when used with the external 2.0 V reference.

Because this sensor is an on-chip sensor, Zilog recommends that the user account for the difference between ambient and die temperature when inferring ambient temperature conditions.

During normal operation, the die undergoes heating that causes a mismatch between the ambient temperature and that measured by the sensor. For best results, the Z8 Encore! XP device must be placed into STOP Mode for sufficient time such that the die and ambient temperatures converge (this time is dependent on the thermal design of the system). The temperature sensor measurement must then be made immediately after recovery from STOP Mode.

The following equation defines the transfer function between the temperature sensor output voltage and the die temperature. This is needed for comparator threshold measurements.

$$V = 0.01 \times T + 0.65$$

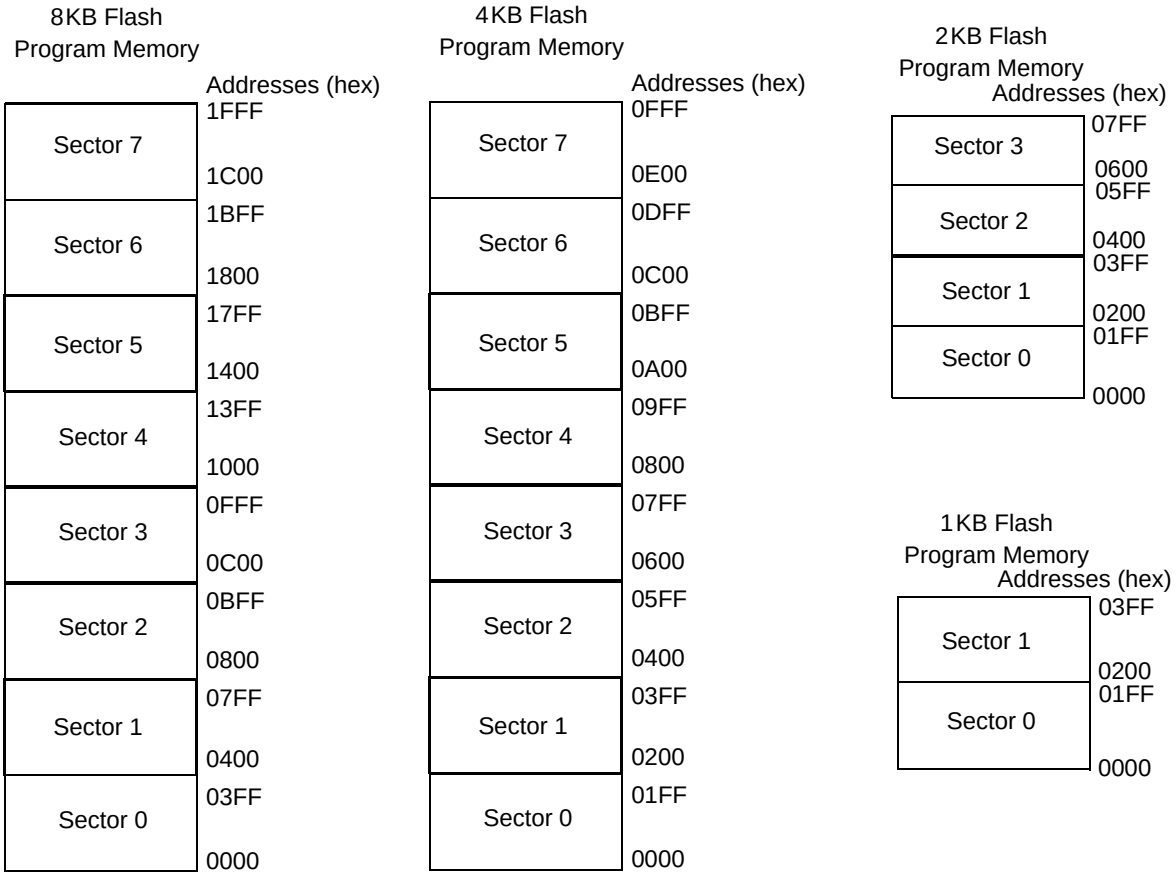


Figure 21. Flash Memory Arrangement

Flash Information Area

The Flash information area is separate from Program Memory and is mapped to the address range FE00H to FFFFH. This area is readable but cannot be erased or overwritten. Factory trim values for the analog peripherals are stored here. Factory calibration data for the ADC is also stored here.

Operation

The Flash Controller programs and erases Flash memory. The Flash Controller provides the proper Flash controls and timing for Byte Programming, Page Erase and Mass Erase of Flash memory.

The Flash Controller contains several protection mechanisms to prevent accidental programming or erasure. These mechanism operate on the page, sector and full-memory levels.

! **Caution:** The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure proper operation of the device. Also, Flash programming and erasure is not supported for system clock frequencies below 20 kHz or above 20 MHz.

Table 84. Flash Frequency High Byte Register (FFREQH)

Bit	7	6	5	4	3	2	1	0
Field	FFREQH							
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	FFAH							

Bit	Description
[7:0] FFREQH	**Flash Frequency High Byte** High byte of the 16-bit Flash Frequency value.

Table 85. Flash Frequency Low Byte Register (FFREQL)

Bit	7	6	5	4	3	2	1	0
Field	FFREQL							
RESET	0							
R/W	R/W							
Address	FFBH							

Bit	Description
[7:0] FFREQL	**Flash Frequency Low Byte** Low byte of the 16-bit Flash Frequency value.

Flash Option Bits

Programmable Flash option bits allow user configuration of certain aspects of Z8 Encore! XP F082A Series operation. The feature configuration data is stored in Flash program memory and loaded into holding registers during Reset. The features available for control through the Flash option bits include:

- Watchdog Timer time-out response selection–interrupt or system reset
- Watchdog Timer always on (enabled at Reset)
- The ability to prevent unwanted read access to user code in Program Memory
- The ability to prevent accidental programming and erasure of all or a portion of the user code in Program Memory
- Voltage Brown-Out configuration-always enabled or disabled during STOP Mode to reduce STOP Mode power consumption
- Oscillator mode selection-for high, medium and low power crystal oscillators, or external RC oscillator
- Factory trimming information for the internal precision oscillator and low voltage detection
- Factory calibration values for ADC, temperature sensor and Watchdog Timer compensation
- Factory serialization and randomized lot identifier (optional)

Operation

This section describes the type and configuration of the programmable Flash option bits.

Option Bit Configuration By Reset

Each time the Flash option bits are programmed or erased, the device must be Reset for the change to take effect. During any reset operation (System Reset, Power-On Reset, or Stop Mode Recovery), the Flash option bits are automatically read from Flash program memory and written to the Option Configuration registers. The Option Configuration registers control the operation of the devices within the Z8 Encore! XP F082A Series. Option bit control is established before the device exits Reset and the eZ8 CPU begins code execution. The Option Configuration registers are not part of the Register File and are not accessible for read or write access.

Temperature Sensor Calibration Data

Table 98. Temperature Sensor Calibration High Byte at 003A (TSCALH)

Bit	7	6	5	4	3	2	1	0
Field	TSCALH							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 003A							

Note: U = Unchanged by Reset. R/W = Read/Write.

Bit	Description
[7:0] TSCALH	**Temperature Sensor Calibration High Byte** The TSCALH and TSCALL bytes combine to form the 12-bit temperature sensor offset calibration value. For more details, see Temperature Sensor Operation on page 139.

Table 99. Temperature Sensor Calibration Low Byte at 003B (TSCALL)

Bit	7	6	5	4	3	2	1	0
Field	TSCALL							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	Information Page Memory 003B							

Note: U = Unchanged by Reset. R/W = Read/Write.

Bit	Description
[7:0] TSCALL	**Temperature Sensor Calibration Low Byte** The TSCALH and TSCALL bytes combine to form the 12-bit temperature sensor offset calibration value. For usage details, see the Temperature Sensor Operation section on page 144.

Table 107. NVDS Read Time

Operation	Minimum Latency	Maximum Latency
Read (16 byte array)	875	9961
Read (64 byte array)	876	8952
Read (128 byte array)	883	7609
Write (16 byte array)	4973	5009
Write (64 byte array)	4971	5013
Write (128 byte array)	4984	5023
Illegal Read	43	43
Illegal Write	31	31

If NVDS read performance is critical to your software architecture, you can optimize your code for speed. Try the first suggestion below before attempting the second.

1. Periodically refresh all addresses that are used. The optimal use of NVDS in terms of speed is to rotate the writes evenly among all addresses planned to use, bringing all reads closer to the minimum read time. Because the minimum read time is much less than the write time, however, actual speed benefits are not always realized.
2. Use as few unique addresses as possible to optimize the impact of refreshing, plus minimize the requirement for it.

Bit	Description (Continued)
[5] DBGACK	**Debug Acknowledge** This bit enables the debug acknowledge feature. If this bit is set to 1, the OCD sends a Debug Acknowledge character (FFH) to the host when a Breakpoint occurs. 0 = Debug Acknowledge is disabled. 1 = Debug Acknowledge is enabled.
[4:1]	**Reserved** These bits are reserved and must be programmed to 0000.
[0] RST	**Reset** Setting this bit to 1 resets the Z8F04xA family device. The device goes through a normal Power-On Reset sequence with the exception that the On-Chip Debugger is not reset. This bit is automatically cleared to 0 at the end of reset. 0 = No effect. 1 = Reset the Flash Read Protect Option Bit device.

OCD Status Register

The OCD Status Register reports status information about the current state of the debugger and the system.

Table 111. OCD Status Register (OCDSTAT)

Bit	7	6	5	4	3	2	1	0
Field	DBG	HALT	FRPENB	Reserved				
RESET	0	0	0	0	0	0	0	0
R/W	R	R	R	R	R	R	R	R

Bit	Description
[7] DBG	**Debug Status** 0 = NORMAL Mode. 1 = DEBUG Mode.
[6] HALT	**HALT Mode** 0 = Not in HALT Mode. 1 = In HALT Mode.
[5] FRPENB	**Flash Read Protect Option Bit Enable** 0 = FRP bit enabled, that allows disabling of many OCD commands. 1 = FRP bit has no effect.
[4:0]	**Reserved** These bits are reserved and must be programmed to 00000.

Table 112. Oscillator Configuration and Selection

Clock Source	Characteristics	Required Setup
Internal Precision RC Oscillator	• 32.8kHz or 5.53MHz • High accuracy • No external components required	• Unlock and write Oscillator Control Register (OSCCTL) to enable and select oscillator at either 5.53MHz or 32.8kHz
External Crystal/ Resonator	• 32kHz to 20MHz • Very high accuracy (dependent on crystal or resonator used) • Requires external components	• Configure Flash option bits for correct external oscillator mode • Unlock and write OSCCTL to enable crystal oscillator, wait for it to stabilize and select as system clock (if the XTLDIS option bit has been deasserted, no waiting is required)
External RC Oscillator	• 32kHz to 4MHz • Accuracy dependent on external components	• Configure Flash option bits for correct external oscillator mode • Unlock and write OSCCTL to enable crystal oscillator and select as system clock
External Clock Drive	• 0 to 20MHz • Accuracy dependent on external clock source	• Write GPIO registers to configure PB3 pin for external clock function • Unlock and write OSCCTL to select external system clock • Apply external clock signal to GPIO
Internal Watchdog Timer Oscillator	• 10kHz nominal • Low accuracy; no external components required • Very low power consumption	• Enable WDT if not enabled and wait until WDT Oscillator is operating • Unlock and write Oscillator Control Register (OSCCTL) to enable and select oscillator

! **Caution:** Unintentional accesses to the Oscillator Control Register can actually stop the chip by switching to a nonfunctioning oscillator. To prevent this condition, the oscillator control block employs a register unlocking/locking scheme.

OSC Control Register Unlocking/Locking

To write the Oscillator Control Register, unlock it by making two writes to the OSCCTL Register with the values E7H followed by 18H. A third write to the OSCCTL Register changes the value of the actual register and returns the register to a locked state. Any other sequence of Oscillator Control Register writes has no effect. The values written to unlock the register must be ordered correctly, but are not necessarily consecutive. It is possible to write to or read from other registers within the unlocking/locking operation.

Oscillator Operation with an External RC Network

Figure 28 displays a recommended configuration for connection with an external resistor-capacitor (RC) network.

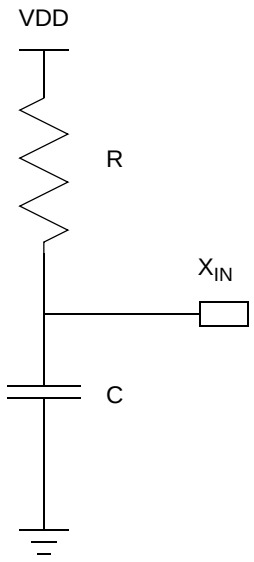


Figure 28. Connecting the On-Chip Oscillator to an External RC Network

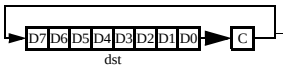
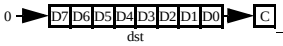
An external resistance value of 45kΩ is recommended for oscillator operation with an external RC network. The minimum resistance value to ensure operation is 40 kΩ. The typical oscillator frequency can be estimated from the values of the resistor (*R* in kΩ) and capacitor (*C* in pF) elements using the following equation:

$$\text{Oscillator Frequency (kHz)} = \frac{1\times10^{6}}{(0.4 \times R \times C) + (4 \times C)}$$

Figure 29 displays the typical (3.3V and 25°C) oscillator frequency as a function of the capacitor (C, in pF) employed in the RC network assuming a 45KΩ external resistor. For very small values of C, the parasitic capacitance of the oscillator X_{IN} pin and the printed circuit board must be included in the estimation of the oscillator frequency.

It is possible to operate the RC oscillator using only the parasitic capacitance of the package and printed circuit board. To minimize sensitivity to external parasitics, external capacitance values in excess of 20pF are recommended.

Table 128. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
RRC dst		R		C0	*	*	*	*	–	–	2	2
		IR		C1							2	3
SBC dst, src	dst ← dst – src - C	r	r	32	*	*	*	*	1	*	2	3
		r	Ir	33							2	4
		R	R	34							3	3
		R	IR	35							3	4
		R	IM	36							3	3
		IR	IM	37							3	4
SBCX dst, src	dst ← dst – src - C	ER	ER	38	*	*	*	*	1	*	4	3
		ER	IM	39							4	3
SCF	C ← 1			DF	1	–	–	–	–	–	1	2
SRA dst		R		D0	*	*	*	0	–	–	2	2
		IR		D1							2	3
SRL dst		R		1F C0	*	*	0	*	–	–	3	2
		IR		1F C1							3	3
SRP src	RP ← src		IM	01	–	–	–	–	–	–	2	2
STOP	STOP Mode			6F	–	–	–	–	–	–	1	2

Note: Flags Notation:
* = Value is a function of the result of the operation.
– = Unaffected.
X = Undefined.
0 = Reset to 0.
1 = Set to 1.

Packaging

Zilog's Product Line of MCUs includes the Z8F011A, Z8F012A, Z8F021A, Z8F022A, Z8F041A, Z8F042A, Z8F081A and Z8F082A devices, which are available in the following packages:

- 8-pin Plastic Dual-Inline Package (PDIP)
- 8-Pin Quad Flat No-Lead Package (QFN)/MLF-S[1]
- 8-pin Small Outline Integrated Circuit Package (SOIC)
- 20-pin Small Outline Integrated Circuit Package (SOIC)
- 20-pin Small Shrink Outline Package (SSOP)
- 20-pin Plastic Dual-Inline Package (PDIP)
- 28-pin Small Outline Integrated Circuit Package (SOIC)
- 28-pin Small Shrink Outline Package (SSOP)
- 28-pin Plastic Dual-Inline Package (PDIP)

Current diagrams for each of these packages are published in Zilog's Packaging Product Specification (PS0072), which is available free for download from the Zilog website.

1. The footprint of the QFN)/MLF-S package is identical to that of the 8-pin SOIC package, but with a lower profile.